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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP		MAX.			UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 62 0.50 - - 0.50							
Case-to-Sink, Flat, Greasd Surface	R _{thCS}			°C/W					
Maximum Junction-to-Case (Drain)	R _{thJC}								
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT		
Static									
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 25	0 μΑ	500	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.55	-	V/°C		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V		
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA		
		$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	25	μA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C		-	-	250			
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =	8.4 A ^b	-	-	0.450	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 8.4 \text{ A}$		8.1	-	-	S		
Dynamic					1	I	I	1	
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	1910	-			
Output Capacitance	Coss			-	290	-			
Reverse Transfer Capacitance	C _{rss}			-	11	-			
Output Capacitance	C _{oss}		V _{DS} = 1.0 \	/, f = 1.0 MHz	-	2730	-	pF	
		$V_{GS} = 0 V$	V _{DS} = 400 V	/, f = 1.0 MHz	-	82	-	1	
Effective Output Capacitance	C _{oss} eff.		$V_{DS} = 0 \text{ V to } 400 \text{ V}^{c}$		-	160	-	1	
Total Gate Charge	Qg				-	-	81		
Gate-Source Charge	Q _{gs}		$I_D = 14 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13^{b}		-	-	20	nC	
Gate-Drain Charge	Q _{gd}				-	-	36		
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10 V	V _{DD} = 250 V, I _D = 14 A, R _g = 7.5 Ω, see fig. 10 ^b		-	15	-	- ns	
Rise Time	t _r				-	39	-		
Turn-Off Delay Time	t _{d(off)}				-	39	-		
Fall Time	t _f			-	-	31	-		
Drain-Source Body Diode Characteristic	s							•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	A		
Pulsed Diode Forward Current ^a	I _{SM}			-	-	56			
Body Diode Voltage	V_{SD}	$T_J = 25 \text{ °C}, I_S = 14 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.5	V		
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 14 \text{ A},$ $T_J = 125 \text{ °C}, dl/dt = 100 \text{ A}/\mu \text{s}^{\text{b}}$		-	370	550	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			-	4.4	6.5	μC		
Body Diode Reverse Recovery Current	I _{RRM}			-	21	31	Α		
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is	negligible (turn	on is dor	ninated b	y L _S and	L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

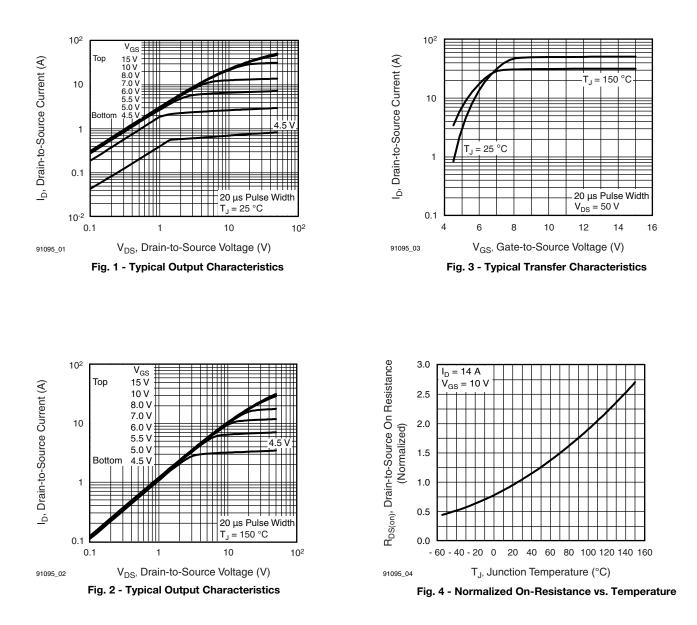
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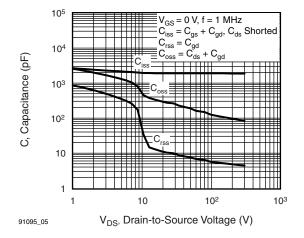


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

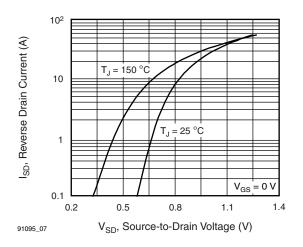


Fig. 7 - Typical Source-Drain Diode Forward Voltage

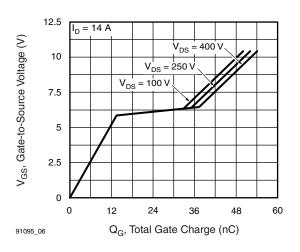


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

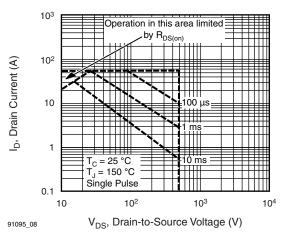


Fig. 8 - Maximum Safe Operating Area

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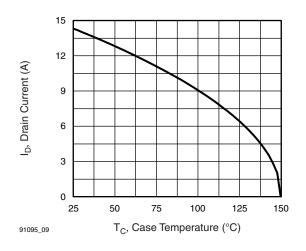


Fig. 9 - Maximum Drain Current vs. Case Temperature

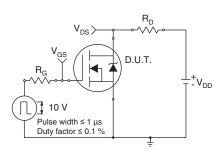


Fig. 10a - Switching Time Test Circuit

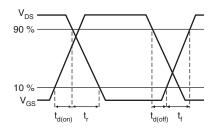


Fig. 10b - Switching Time Waveforms

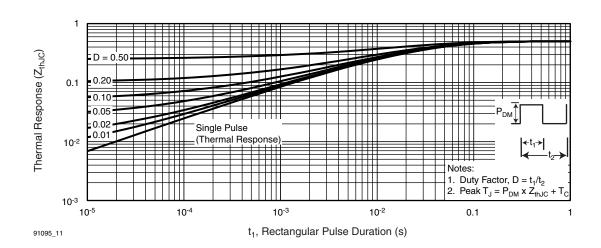


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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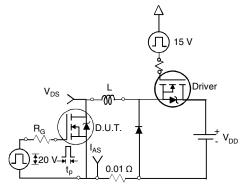


Fig. 12a - Unclamped Inductive Test Circuit

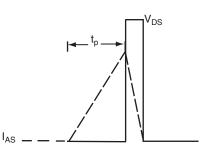


Fig. 12b - Unclamped Inductive Waveforms

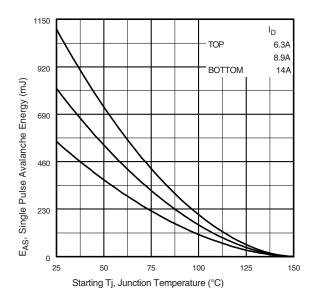
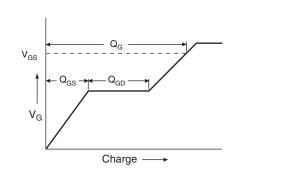


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





Current regulator Same type as D.U.1 50 kΩ 0.3 uł V_{DS} D.U.T. V_{GS} ; 3 m A 🕽 📗 \sim I_G I_D Current sampling resistors

Fig. 13b - Gate Charge Test Circuit

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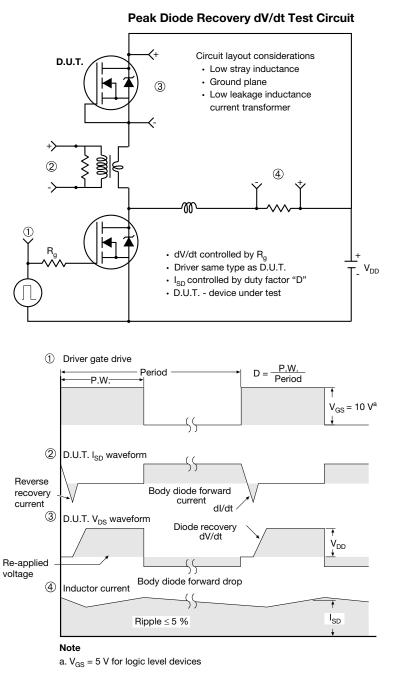


Fig. 14 - For N-Channel

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reliability data, see <u>www.vishay.com/ppg?91095</u>.

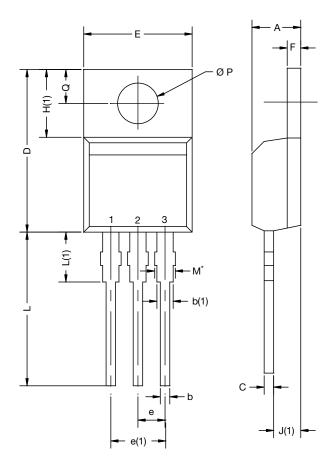
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DIM.	MILLIN	IETERS	INCHES		
DINI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
-	0364-Rev. C,		0.100	0.118	

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture							
ASE	Xi'an						

Revison: 14-Dec-15

Document Number: 66542

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